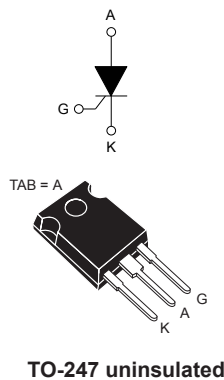


50 A 1200 V automotive grade thyristor (SCR)



Features

- AEC-Q101 qualified 
- Blocking voltage: +/- 1200 V
- On-state current: 50 A_{RMS}
- High static and dynamic commutation:
 - $di/dt = 200 \text{ A}/\mu\text{s}$
 - $dV/dt = 1000 \text{ V}/\mu\text{s}$
- $I_{GT} = 50 \text{ mA}$
- ECOPACK2 compliant component

Applications

- Automotive applications: on board and off board battery charger
- Renewable energy inverters
- Solid state relay
- Overvoltage crowbar protection
- UPS (uninterruptible power supply)
- Bypass SSR / hybrid relay
- Inrush current limiter in battery charger
- AC-DC voltage controlled rectifier
- Industrial welding systems

Description

Available in TO-247 high power package, the **TN5050H-12WY** autograde is suitable in applications such as automotive / stationary battery charger, renewable energy generator, interruptible power supply, solid state relay, welding equipment and motor drive applications.

Its power switching, voltage robustness and power dissipation performances are the key features for functions such as a 80 A AC switch, an AC phasing inverter and an AC-DC controlled rectifier bridge.

The **TN5050H-12WY** is an automotive grade product and offers a superior performance in surge current handling, thermal cooling capabilities and overvoltage robustness.

Product status	
TN5050H-12WY	
Product summary	
$I_{T(RMS)}$	50 A
V_{DRM}/V_{RRM}	1200 V
V_{DSM}/V_{RSM}	1300 V
I_{GT}	50 mA
T_j	150 °C

1 Characteristics

Table 1. Absolute ratings (limiting values)

Symbol	Parameter		Value	Unit	
I _{T(RMS)}	RMS on-state current (180 ° conduction angle)		50	A	
I _{T(AV)}	Average on-state current (180 ° conduction angle)				
I _{T(RMS)}	RMS on-state current (180 ° conduction angle)		80	A	
I _{T(AV)}	Average on-state current (180 ° conduction angle)				
I _{TSM} ⁽¹⁾	Non repetitive surge peak on-state current, V _R = 0 V	t _p = 8.3 ms	T _j initial = 25 °C	633	
		t _p = 10 ms		580	
V _{DRM} / V _{RRM}	Repetitive off-state voltage (50-60 Hz)		T _j = 150 °C	1200	V
di/dt	I _G = 2 x I _{GT} , tr ≤ 100 ns	f = 50 Hz	T _j = 150 °C	200	A/μs
	Critical rate of rise of on-state current				
I _{GM}	Peak forward gate current	t _p = 20 μs	T _j = 150 °C	8	A
P _{G(AV)}	Average gate power dissipation		T _j = 150 °C	1	W
T _{stg}	Storage junction temperature range			-40 to +150	°C
T _j	Operating junction temperature			-40 to +150	°C

1. ST recommend I^2t value for fusing = 1680 A²s for $T_j = 25$ °C and $t_p = 10$ ms

Table 2. Electrical characteristics ($T_j = 25$ °C unless otherwise specified)

Symbol	Test Conditions			Value	Unit
I _{GT}	V _D = 12 V, R _L = 33 Ω		Min.	10	mA
			Max.	50	
V _{GT}	V _D = 12 V, R _L = 33 Ω		Max.	1	V
V _{GD}	V _D = 2/3 x V _{DRM} , R _L = 3.3 kΩ	T _J = 150 °C	Min.	0.15	V
I _H	I _T = 500 mA, gate open		Max.	100	mA
I _L	I _G = 1.2 x I _{GT}		Max.	125	mA
t _{gt}	I _T = 50 A , V _D = V _{DRM} , I _G = 200 mA, dI _G /dt = 0.2 A/μs		Typ.	3	μs
dV/dt	V _D = 2/3 x V _{DRM} , gate open	T _J = 150 °C	Min.	1000	V/μs
t _q	I _T = 33 A, dI _T /dt = 10 A/μs, V _R = 75 V, V _D = 800 V, dV _D /dt = 20 V/μs, t _p = 100 μs	T _J = 150 °C	Typ.	150	μs
V _{TM}	I _{TM} = 100 A, t _p = 380 μs		Max.	1.55	V
V _{TO}	On-state threshold voltage	T _J = 150 °C	Max.	0.88	V
R _D	On-state dynamic resistance	T _J = 150 °C	Max.	6	mΩ
I _{DRM} /I _{RRM}	V _D = V _{DRM} , V _R = V _{RRM}	T _J = 25 °C	Max.	5	μA
		T _J = 125 °C	Max.	3	mA
		T _J = 150 °C	Max.	7.5	mA
I _{DSM} /I _{RSM}	V _D = V _{DSM} , V _R = V _{RSM}	T _J = 25 °C	Max.	10	μA

Table 3. Thermal parameters

Symbol	Parameter		Value	Unit
$R_{th(j-c)}$	Junction to case (DC, max.)	TO-247	0.3	°C/W
$R_{th(j-a)}$	Junction to ambient (typ.)		50	

1.1 Characteristics curves

Figure 1. Maximum average power dissipation versus average on-state current

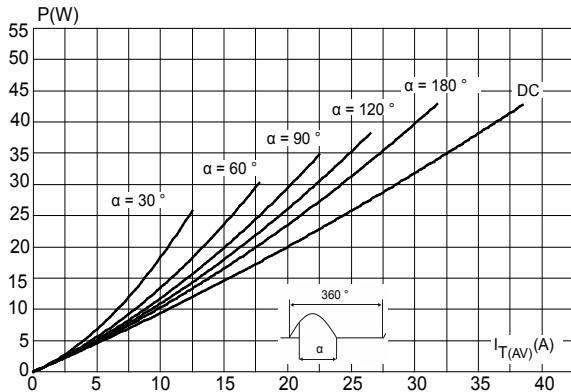


Figure 2. Correlation between maximum average power dissipation and maximum allowable temperatures (T_{amb} and T_{case})

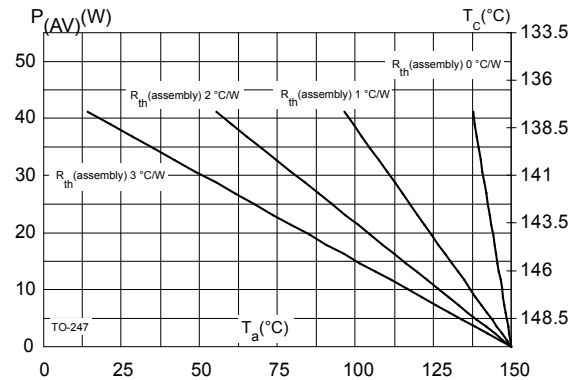


Figure 3. Average and DC on-state current versus case temperature

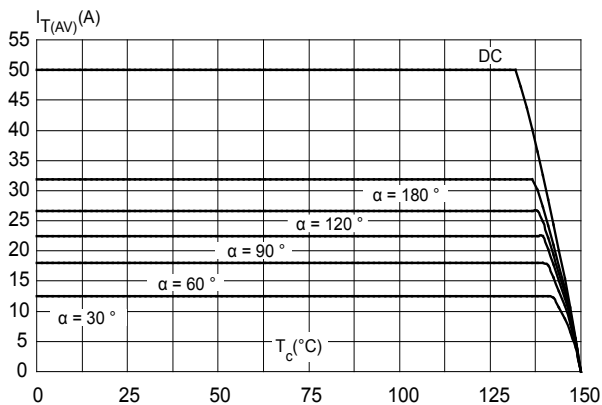


Figure 4. Average and D.C. on-state current versus ambient temperature

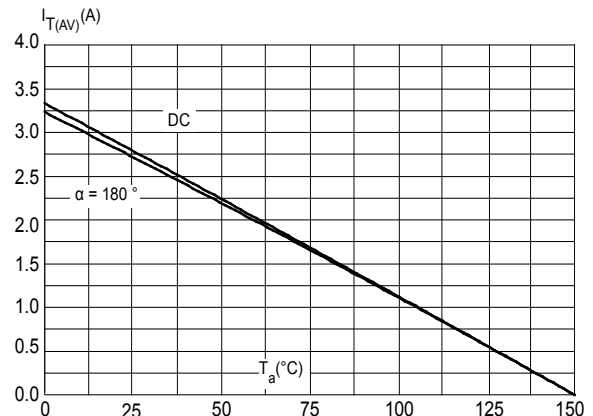


Figure 5. Relative variation of thermal impedance junction to case and junction to ambient versus pulse duration

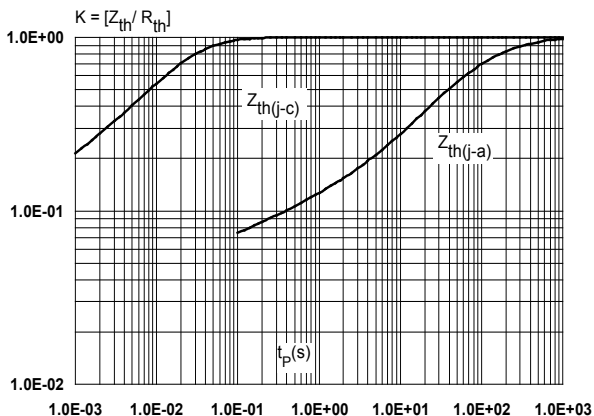


Figure 6. Relative variation of gate trigger current and gate voltage versus junction temperature (typical values)

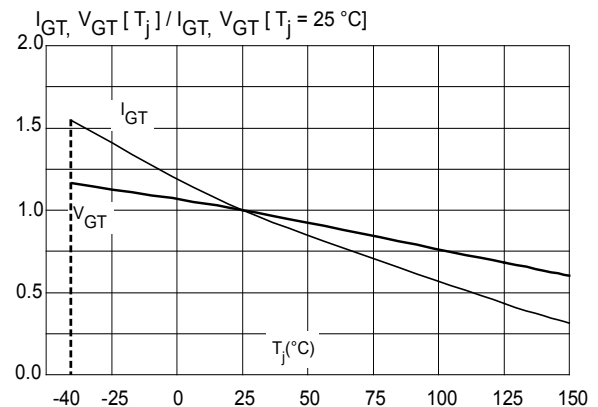
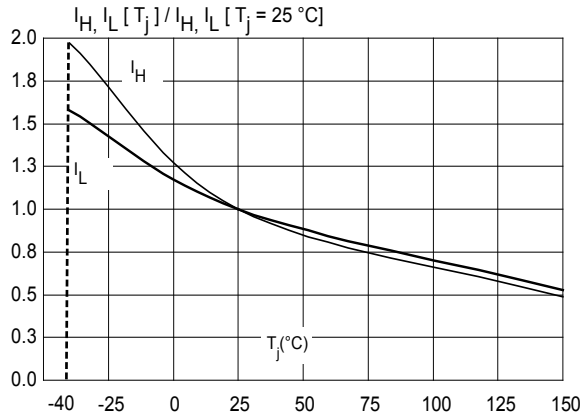
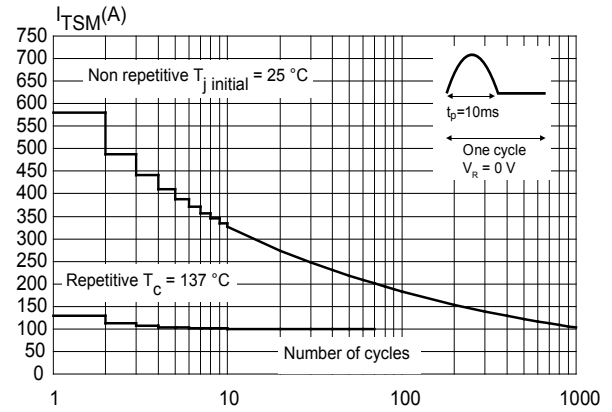
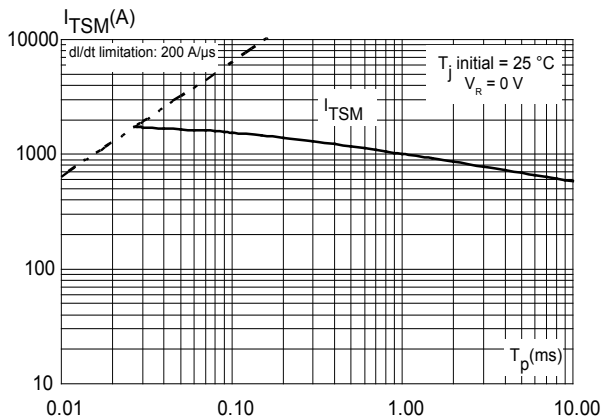
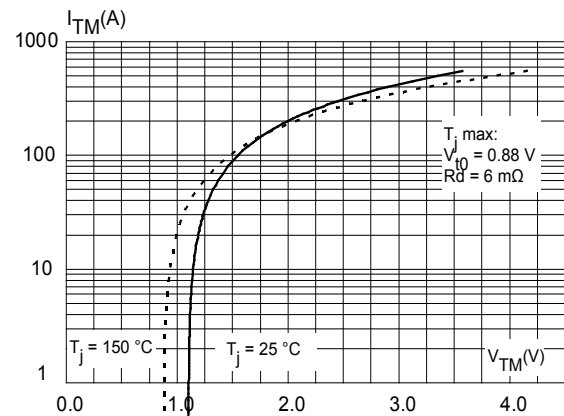
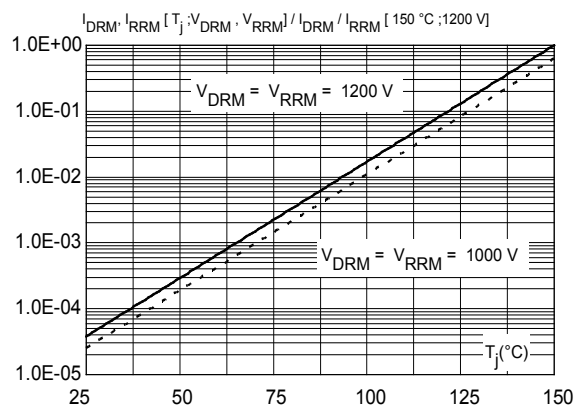


Figure 7. Relative variation of holding and latching current versus junction temperature (typical values)

Figure 8. Surge peak on-state current versus number of cycles

Figure 9. Non repetitive surge peak on-state current for a sinusoidal pulse ($t_p < 10\text{ ms}$)

Figure 10. On-state characteristics (maximum values)

Figure 11. Relative variation of leakage current versus junction temperature for different values of blocking voltage (typical values)


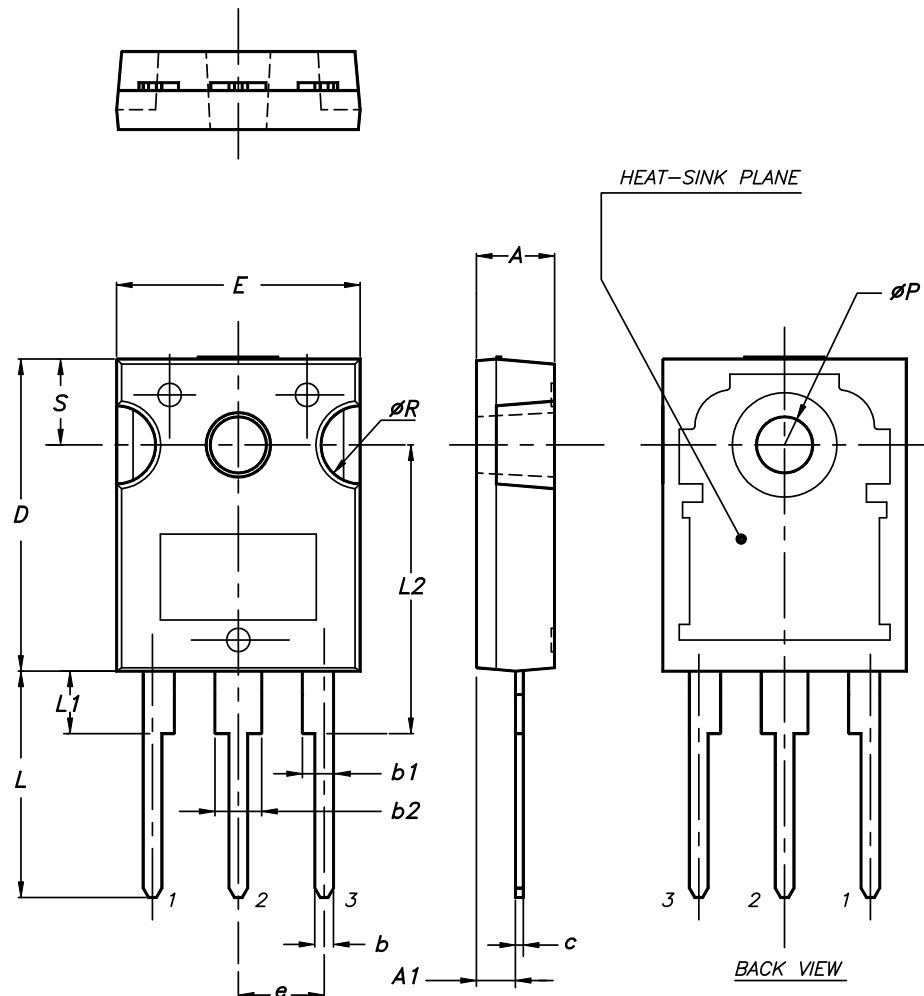
2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 TO-247 package information

- Epoxy meets UL 94,V0
- Recommended torque value: 0.8 N·m
- Maximum torque value: 1 N·m

Figure 12. TO-247 package outline



0075325_9

Table 4. TO-247 package mechanical data

Dim.	Dimensions					
	Millimeters			Inches ⁽¹⁾		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.85		5.15	0.1909		0.2028
A1	2.20		2.60	0.0866		0.1024
b	1.0		1.40	0.0394		0.0551
b1	2.0		2.40	0.0787		0.0945
b2	3.0		3.40	0.1181		0.1339
c	0.40		0.80	0.0157		0.0315
D ⁽²⁾	19.85		20.15	0.7815		0.7933
E	15.45		15.75	0.6083		0.6201
e	5.30	5.45	5.60	0.2087	0.2146	0.2205
L	14.20		14.80	0.5591		0.5827
L1	3.70		4.30	0.1457		0.1693
L2		18.50			0.7283	
ØP ⁽³⁾	3.55		3.65	0.1398		0.1437
ØR	4.50		5.50	0.1772		0.2165
S	5.30	5.50	5.70	0.2087	0.2165	0.2244

1. Inch dimensions given only for reference
2. Dimension D plus gate protrusion does not exceed 20.5 mm
3. Resin thickness around the mounting hole is not less than 0.9 mm

3 Ordering information

Table 5. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
TN5050H-12WY	TN5050H12Y	TO-247	4.43 g	30	Tube

Revision history

Table 6. Document revision history

Date	Revision	Changes
07-Jan-2015	1	Initial release.
17-Oct-2017	2	Updated TO-247 package information.
20-Dec-2017	3	Updated Table 5: "TO-247 package mechanical data".
11-Sep-2019	4	Updated Table 1 and Figure 8. Minor text change.
27-Feb-2020	5	Minor text change to improve the readability of the document.

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